



Transport properties in layered thermoelectric chalcogenides

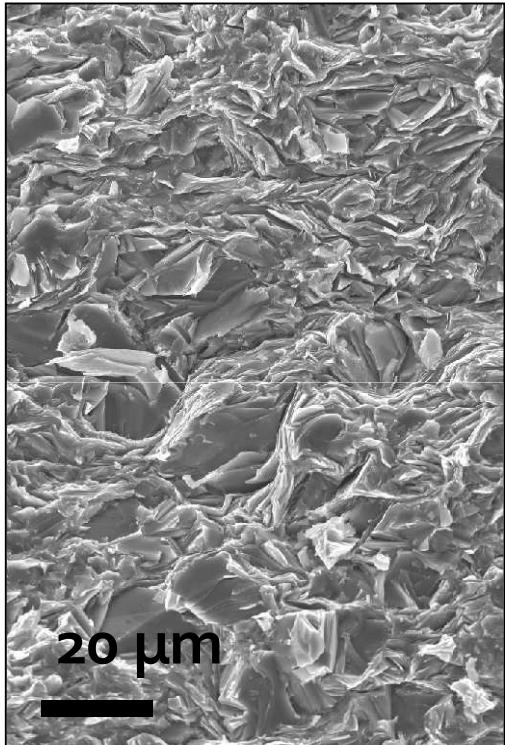
Intercalation, substitution and non stoichiometry : three different approaches to increase phonon scattering in TiS_2

-26 February 2014 -

Emmanuel Guilmeau

EPSRC Workshop, Manchester

Summary



1. MS_2 Layered Dichalcogenides
2. Intercalation : the case of copper and silver
3. Heavy metal cations Substitution (Ta, Nb)
4. Non-stoichiometry: Tuning of TE properties and structural disordering

MS_2 layered Dichalcogenides



MS_2 Layered Structure

- ❑ Trigonal prismatic or octahedral
- ❑ Hexagonal packed planes
- ❑ Van-der-Waals interaction between layers
- ❑ Alkali, Metal intercalation

Electronic Properties

- ❑ Insulating-SC-Metal
- ❑ Degree of filling of d bands (metal)
- ❑ Non stoichiometry

MS₂ compounds

Intercalation

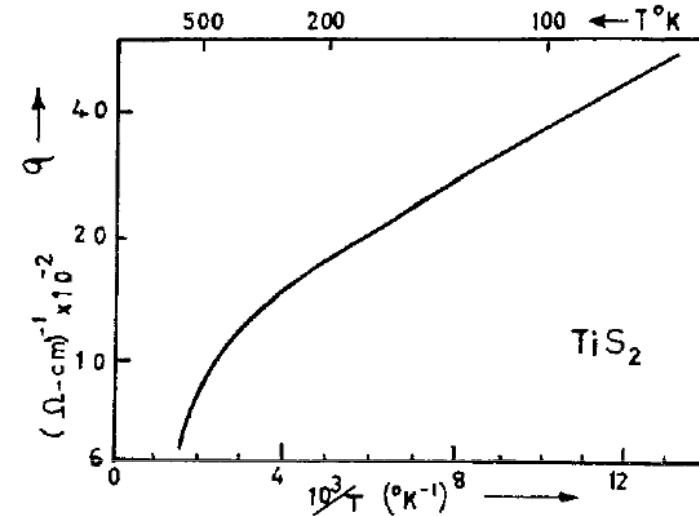
Substitution

Non-stoichiometry

MS_2 layered Dichalcogenides

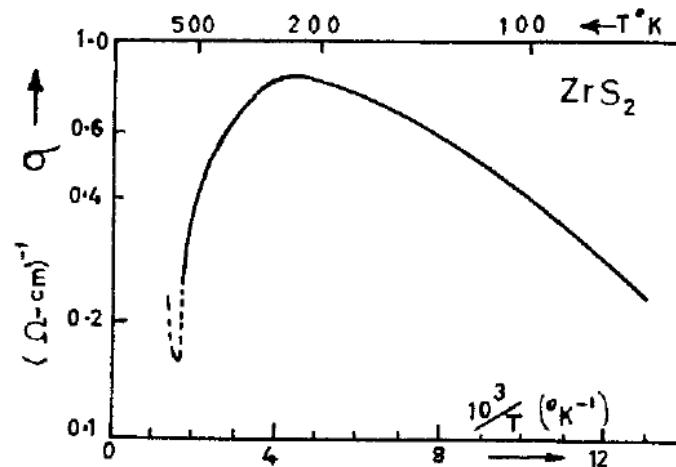
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J.A.Wilson and A.D. Yoffe, Adv. Phys (1969)

MS₂ compounds

Intercalation

Substitution

Non-stoichiometry

MS_2 layered Dichalcogenides



MS_2 Layered Structure

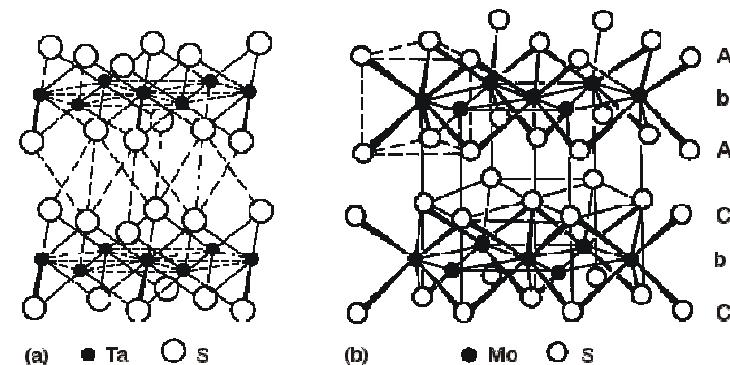
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- ❑ Hexagonal packed planes
- ❑ Van-der-Waals interaction between layers
- ❑ Alkali, Metal intercalation

Strong Anisotropy

- ❑ Two-dimensional character, e.g. electrical and thermal properties
- ❑ Electron mobility in CdI_2 planes
- ❑ Phonon scattering along c direction

Electronic Properties

- ❑ Insulating-SC-Metal
- ❑ Degree of filling of d bands (metal)
- ❑ Non stoichiometry



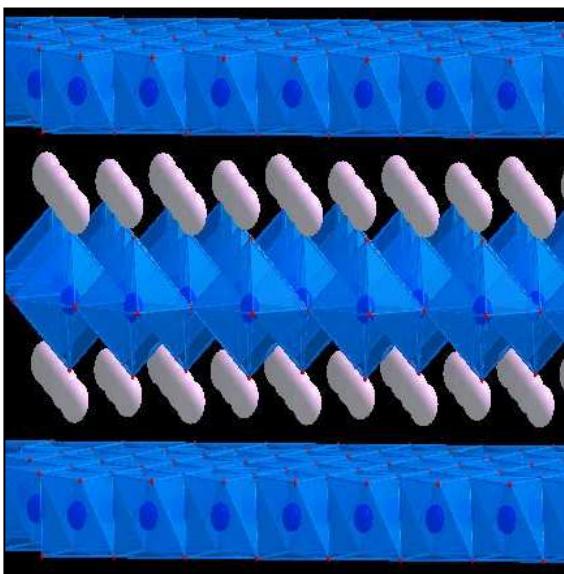
MS₂ compounds

Intercalation

Substitution

Non-stoichiometry

MS₂ layered Dichalcogenides



An Oxide Single Crystal with High Thermoelectric Performance in Air

Ryoji FUNAHASHI*, Ichiro MATSUBARA, Hiroshi IKUTA¹, Tsunehiro TAKEUCHI², Uichiro MIZUTANI² and Satoshi SODEOKA

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(Received September 27, 2000; accepted for publication October 6, 2000)

Misfit-layered cobaltite with an anisotropic giant magnetoresistance: Ca₃Co₄O₉

A. C. Masset, C. Michel,* A. Maignan, M. Hervieu, O. Toulemonde, F. Studer, and B. Raveau
Laboratoire CRISMAT, UMR 6508 associée au CNRS, ISMRA et Université de Caen 6, Boulevard du Maréchal Juin,
14050 CAEN Cedex, France

J. Hejtmanek

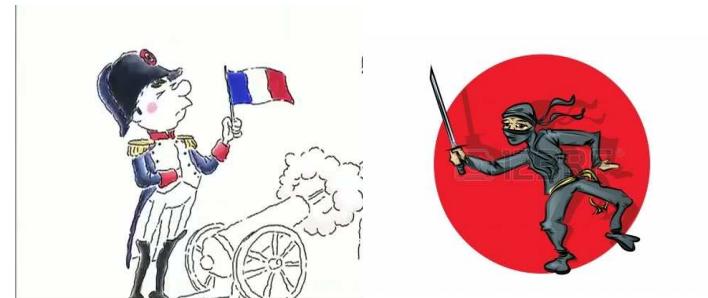
Laboratory of Oxidic Materials, Institute of Physics, 162 53 Prague 6, Cukrovarnicka 10, Czech Republic

(Received 1 February 2000)

A. C. Masset et al., PR B 62, 166, 2000

R. Funahashi et al., JJAP 39, L1127, 2000

$$\rightarrow S = +120 \mu\text{V/K}$$



MS₂ compounds

Intercalation

Substitution

Non-stoichiometry

Why TiS_2 as a TE element?



Criteria for thermoelectricity

Narrow band-gap semiconductor

Low electrical resistivity, high Seebeck coefficient

$n = 10^{20} \text{ cm}^{-3}$
High Power factor
 $1.7 \text{ mW/mK}^2 @ 300\text{K}$

Flexible compositions for tuning transport properties

Optimum carrier concentration



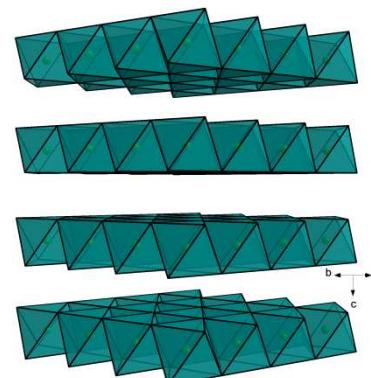
Large unit cell, complex structure, disorder

Low thermal conductivity



Heavy elements

Low thermal conductivity



TARGET:
Decrease thermal conductivity

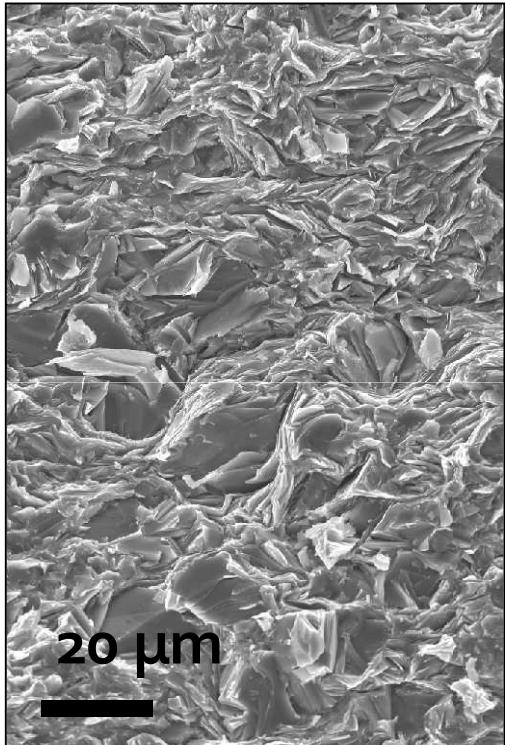
MS₂ compounds

Intercalation

Substitution

Non-stoichiometry

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MS₂ compounds

Intercalation

Substitution

Non-stoichiometry

Material Processing

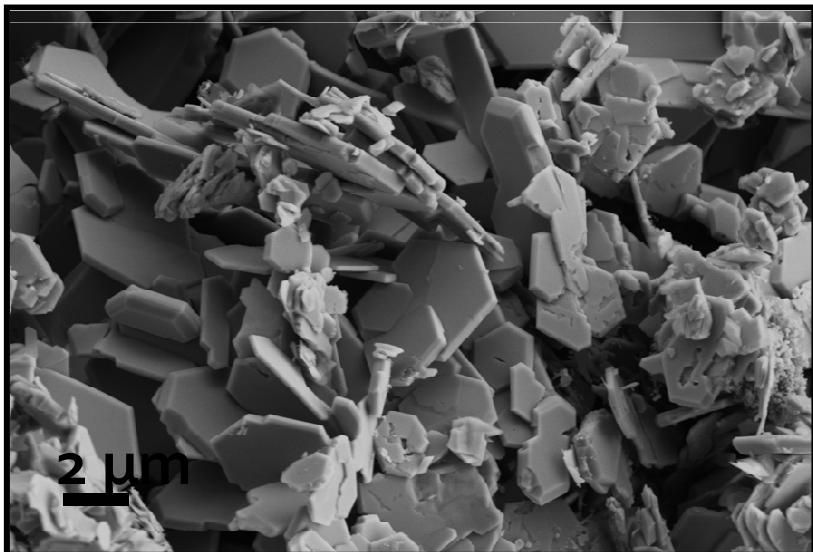


Powder

Sealed tube synthesis (650°C/12h)

Grain size
(5 µm)

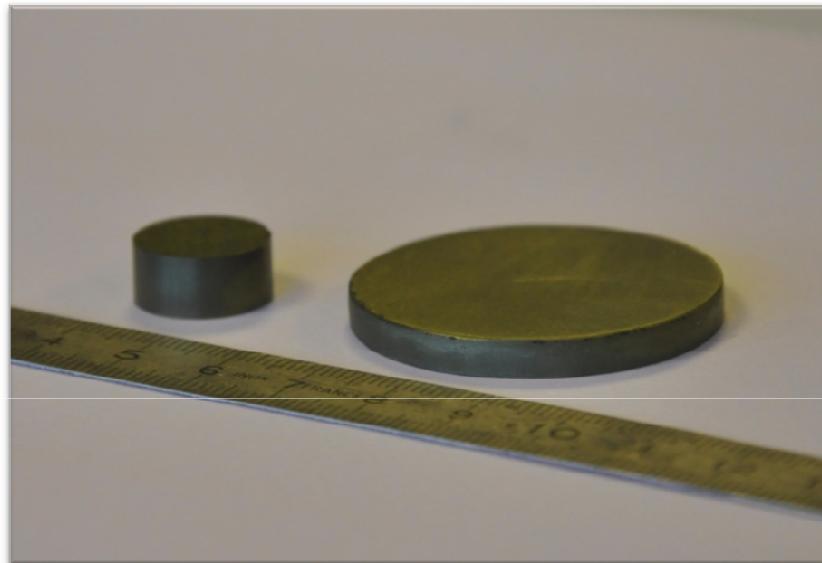
Traces of TiO₂



MS₂ compounds

Intercalation

Bulk



SPS Sintering 600-900°C 50-300 MPa

Relative Density
> 95%

Grain size
(20 µm)

Slight (001) texture

Substitution

Non-stoichiometry

Material Processing

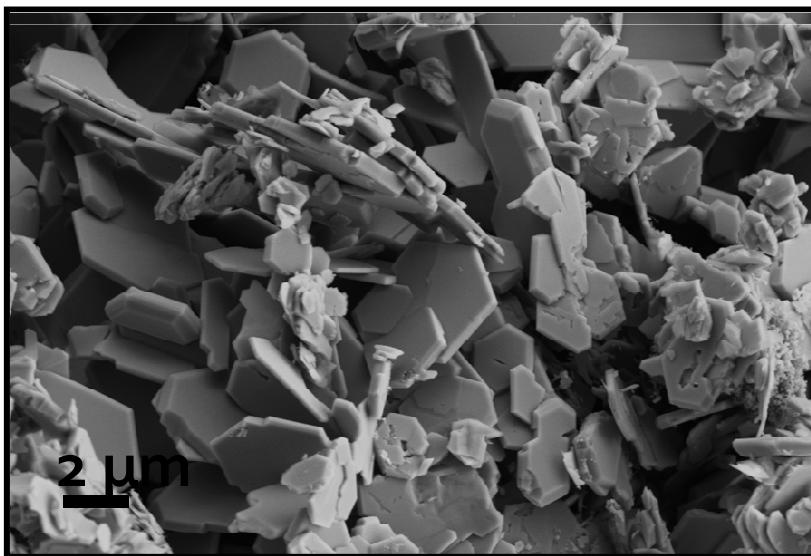


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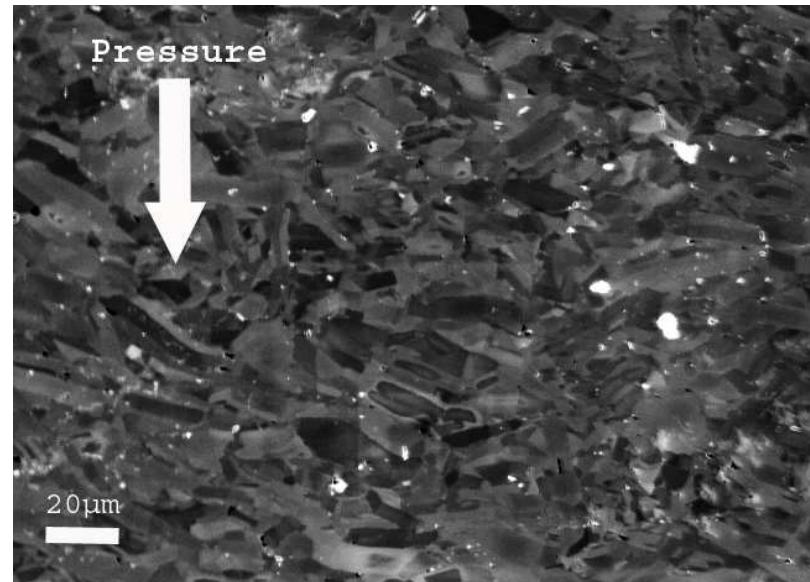
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MS₂ compounds

Intercalation

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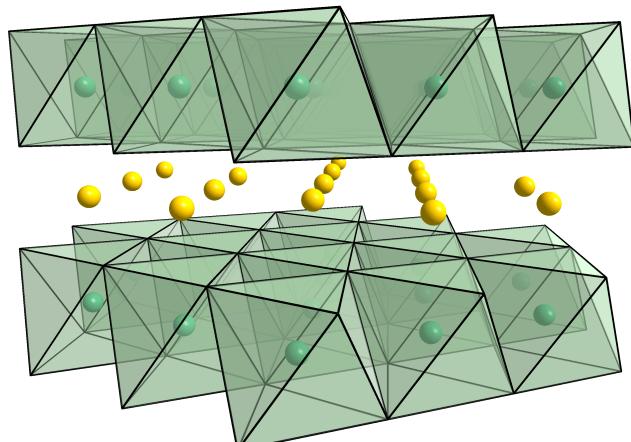
Substitution

Non-stoichiometry

Intercalation in TiS_2

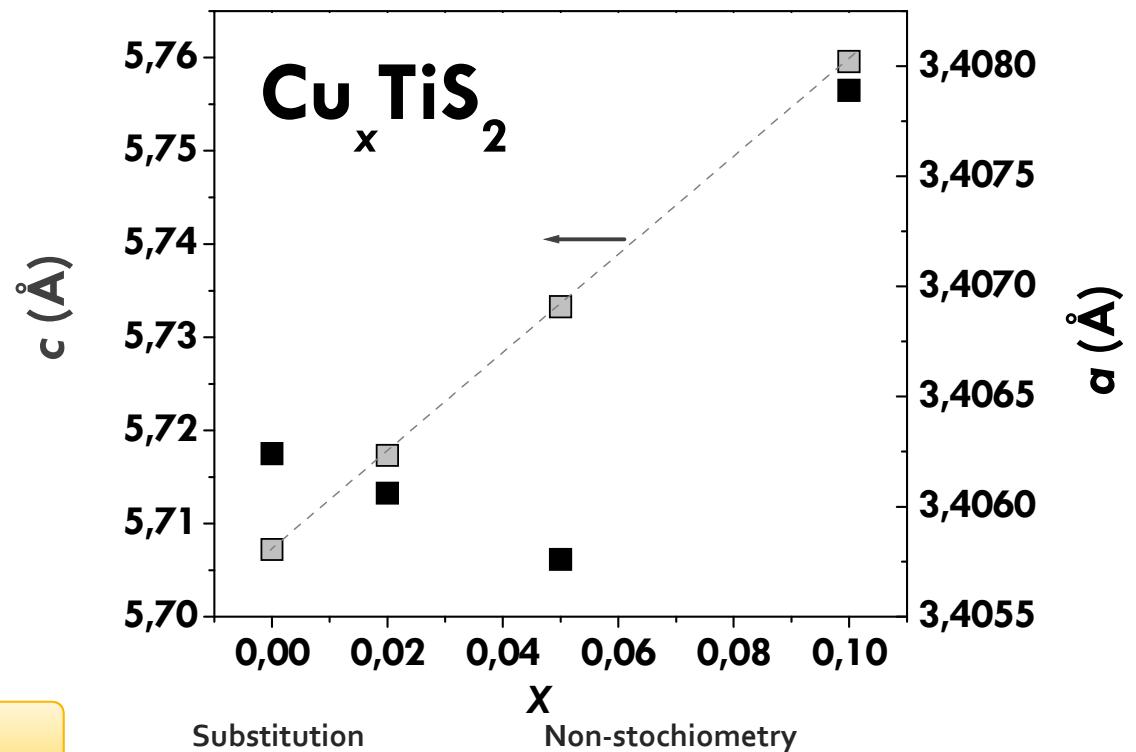
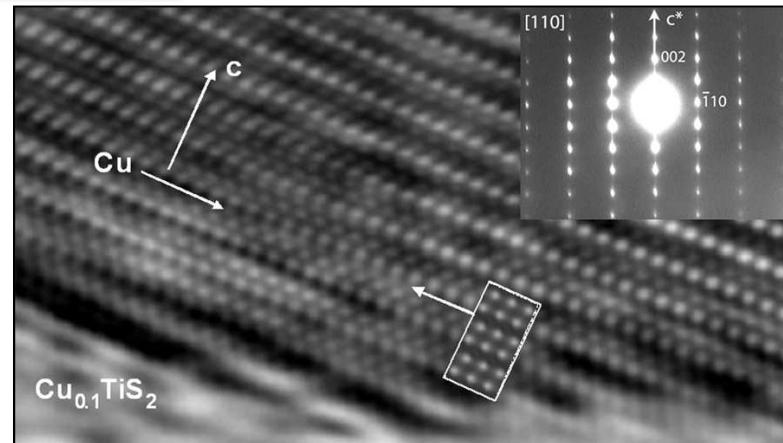
Synthesis and Structure

- Copper diffusion by In Situ SPS
- High density (>95%)
- Slight (001) texture
- c cell parameter increase
- TEM: Elongated dot reflexion
→ Disorder



MS₂ compounds

Intercalation

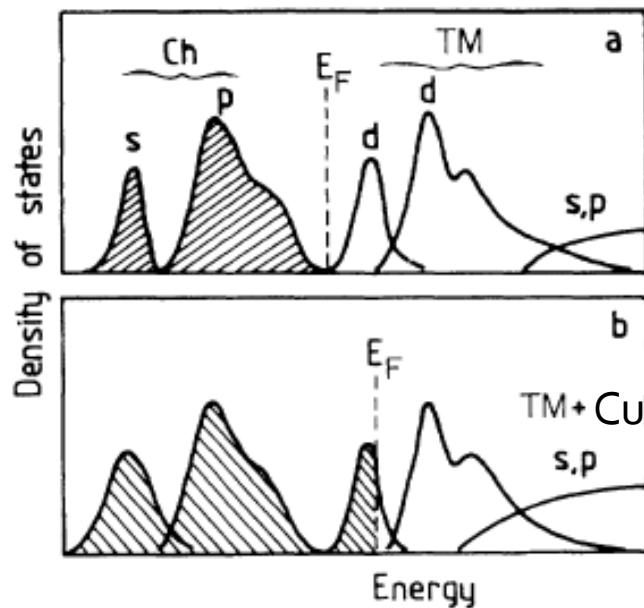


Intercalation in TiS_2



Electrical Properties

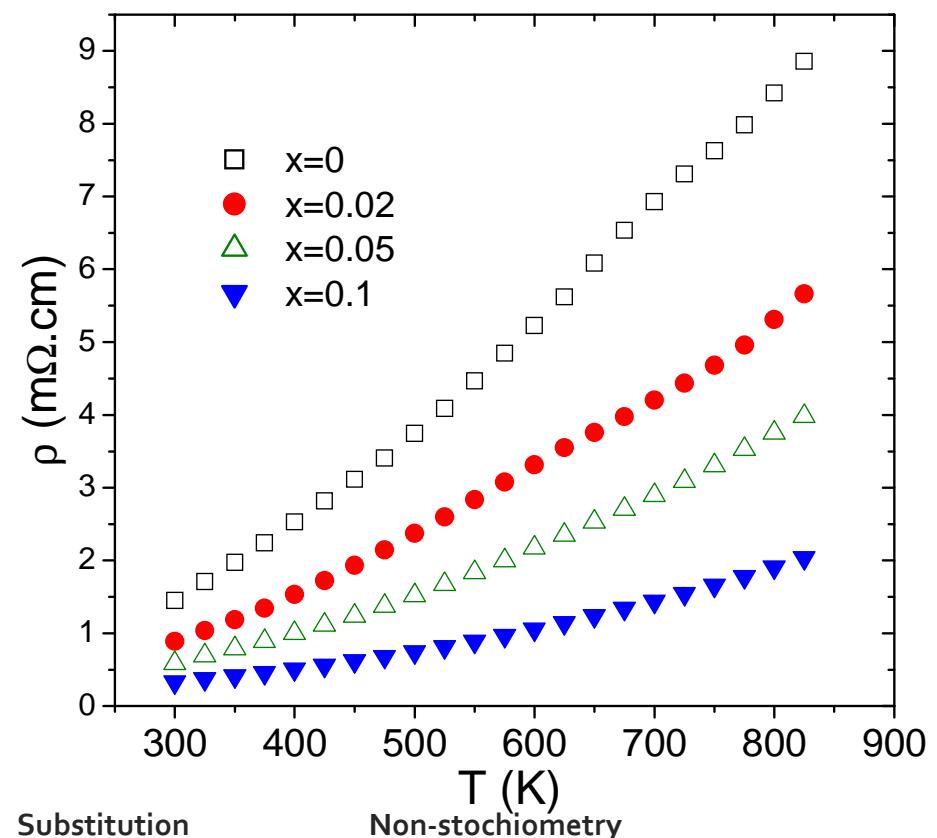
- Increase in carrier concentration
- Charge Transfer to conduction band ($\text{Ti } 3\text{d}$)
- Decreased electrical resistivity and Seebeck coeff.



MS₂ compounds

Intercalation

E. Guilmeau *et al.*, APL (2011)



Substitution

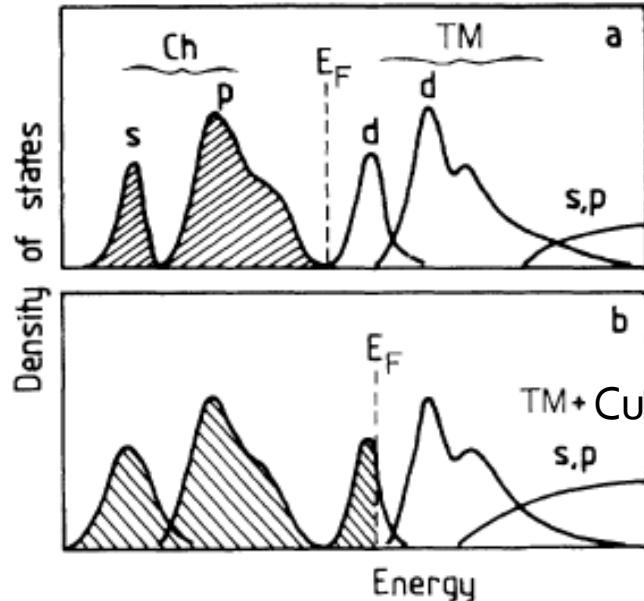
Non-stoichiometry

Intercalation in TiS_2



Electrical Properties

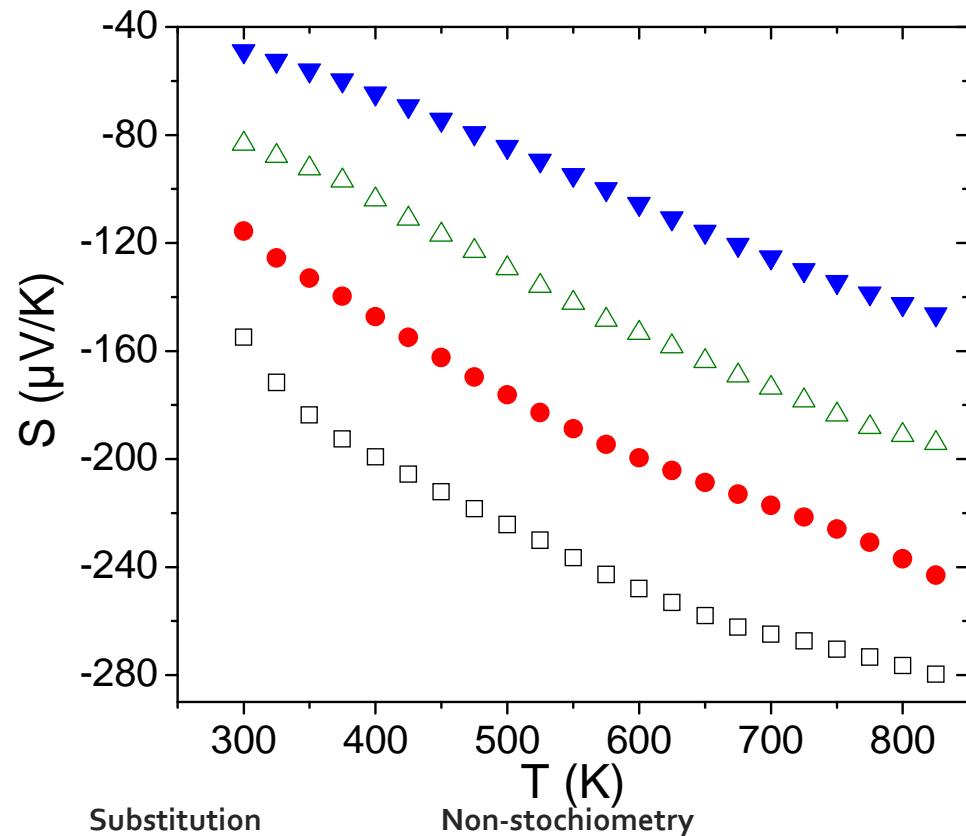
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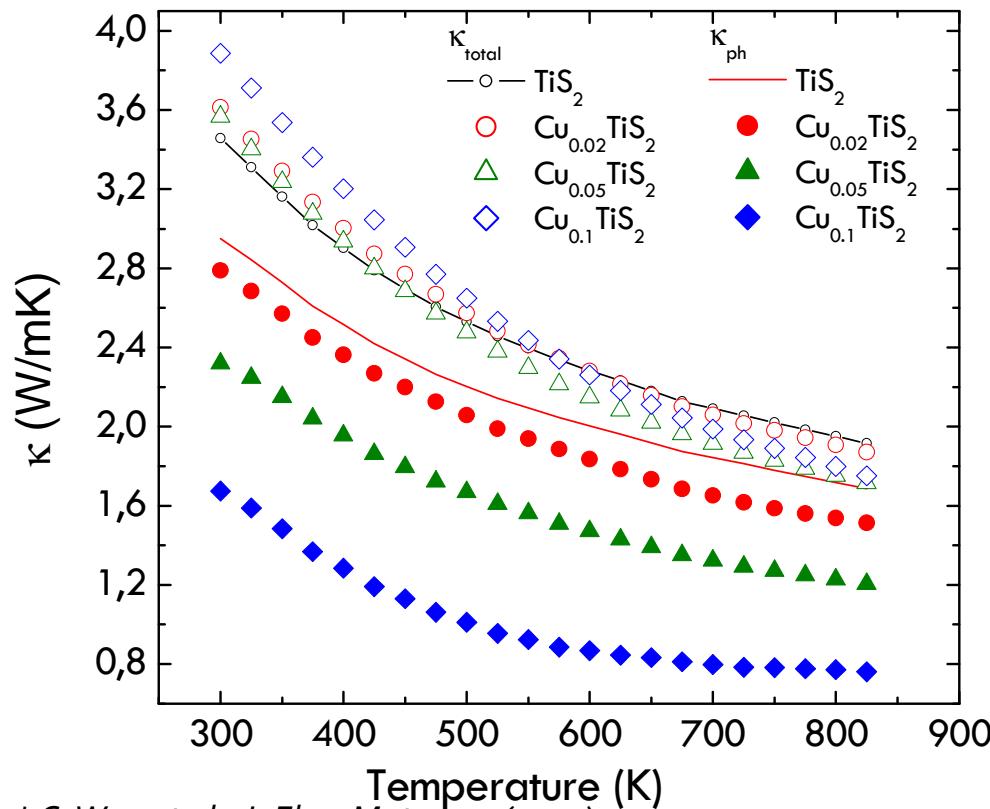


Intercalation in TiS_2



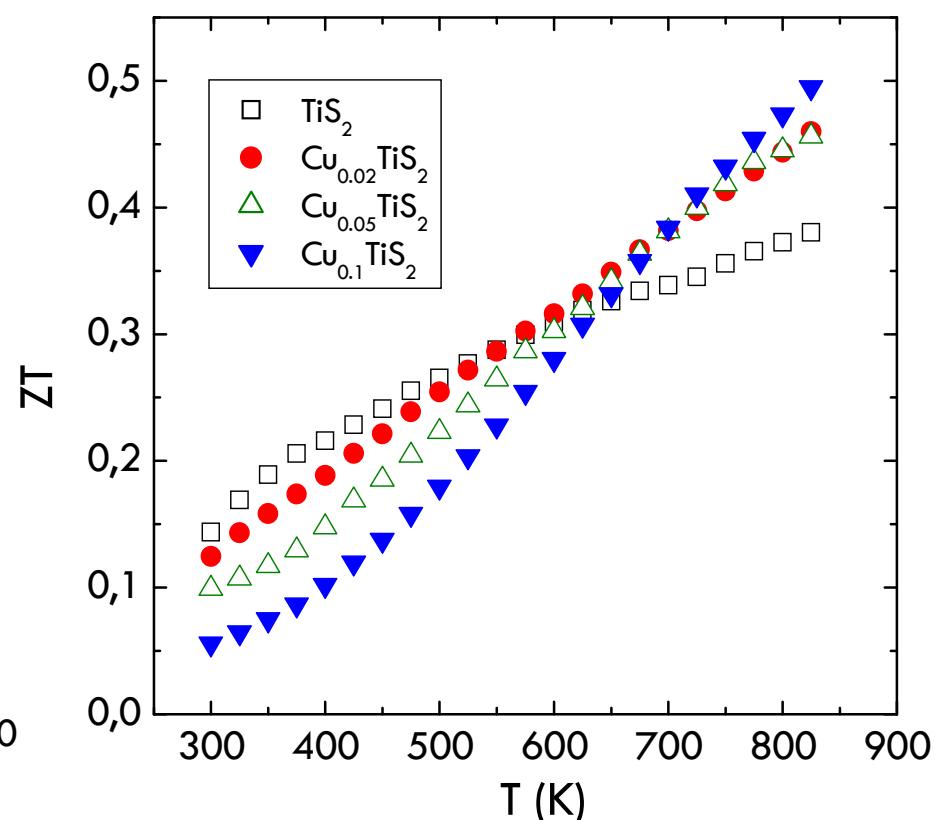
Thermal Properties

- Decrease in lattice Thermal cond.
- Phonon scattering due to local Disorder
- Disruption of periodicity along the c axis*



* C. Wan et al., J. Elec. Mater. 40 (2011) 1271

- Moderate increase in ZT (0.35@ 700K)
- Rather high kappa values



MS₂ compounds

Intercalation

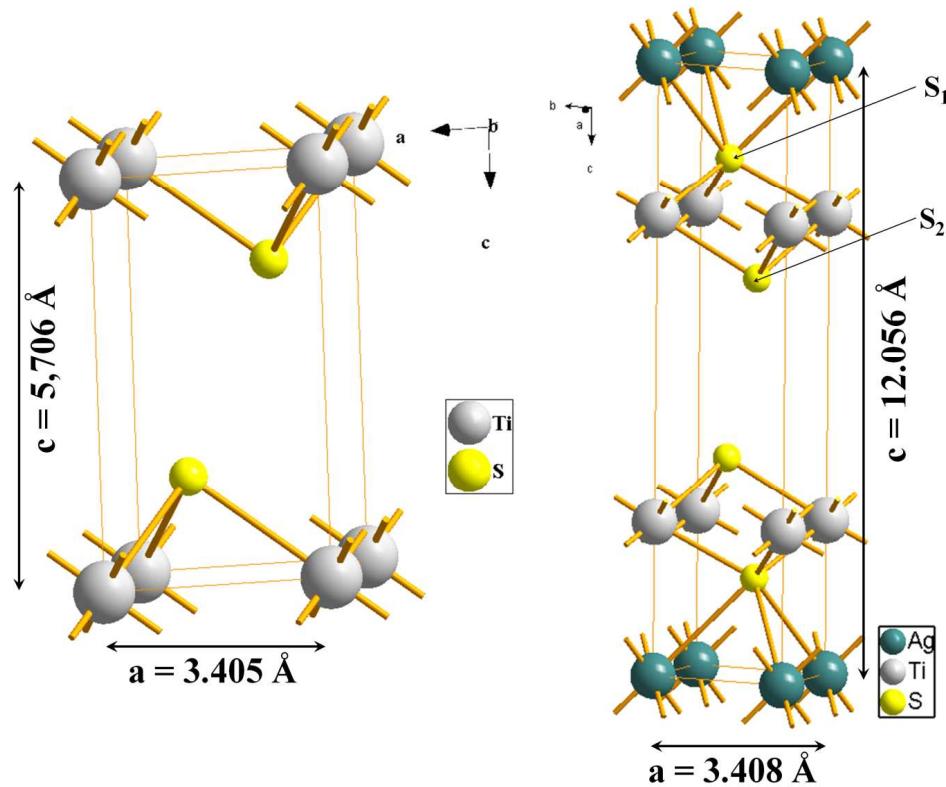
Substitution

Non-stoichiometry

Intercalation in TiS_2

Ag_xTiS_2

- Different Intercalation mechanism
- Increase in ZT up to 0.46 @ 700K

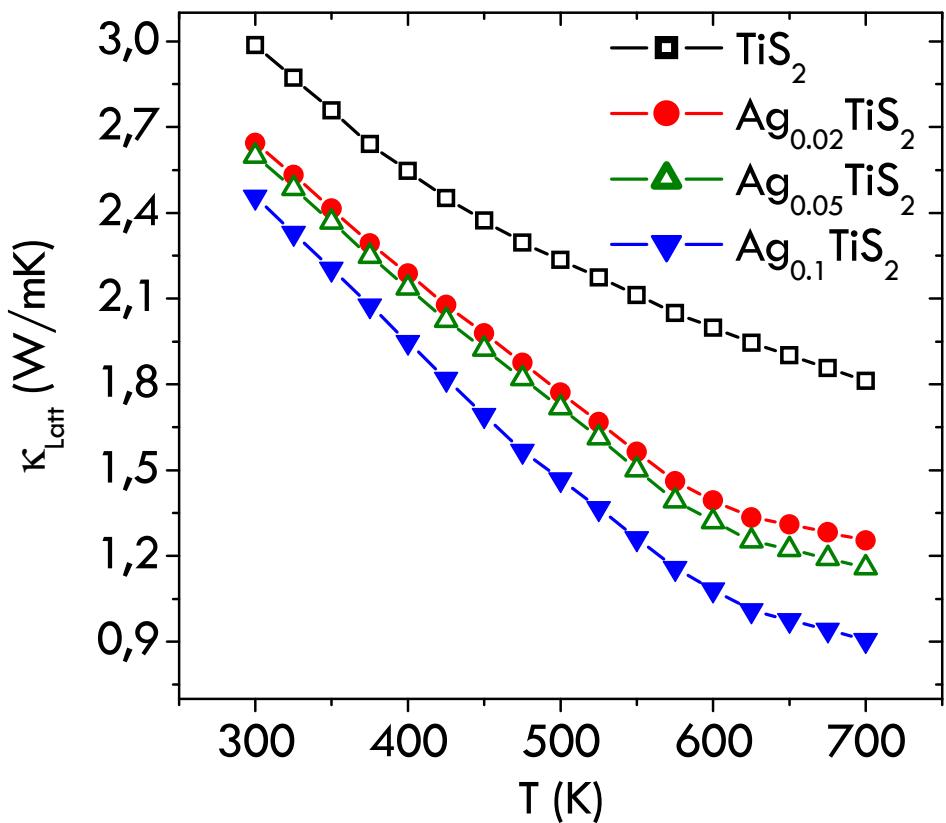


MS₂ compounds

Intercalation

Substitution

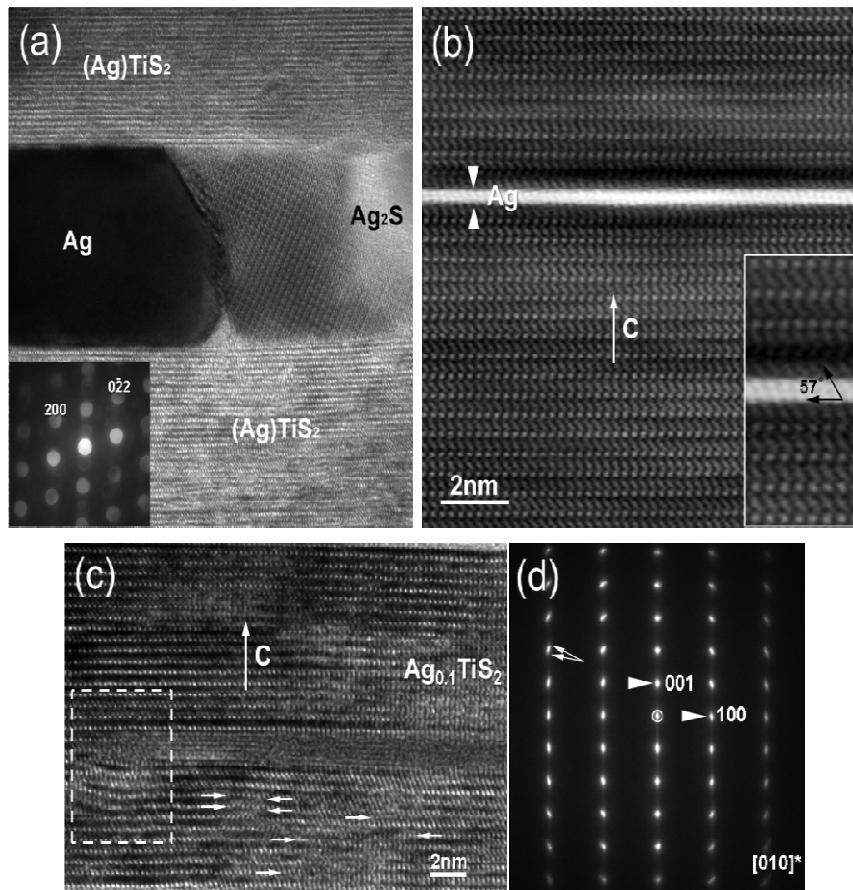
Non-stoichiometry



Intercalation in TiS_2

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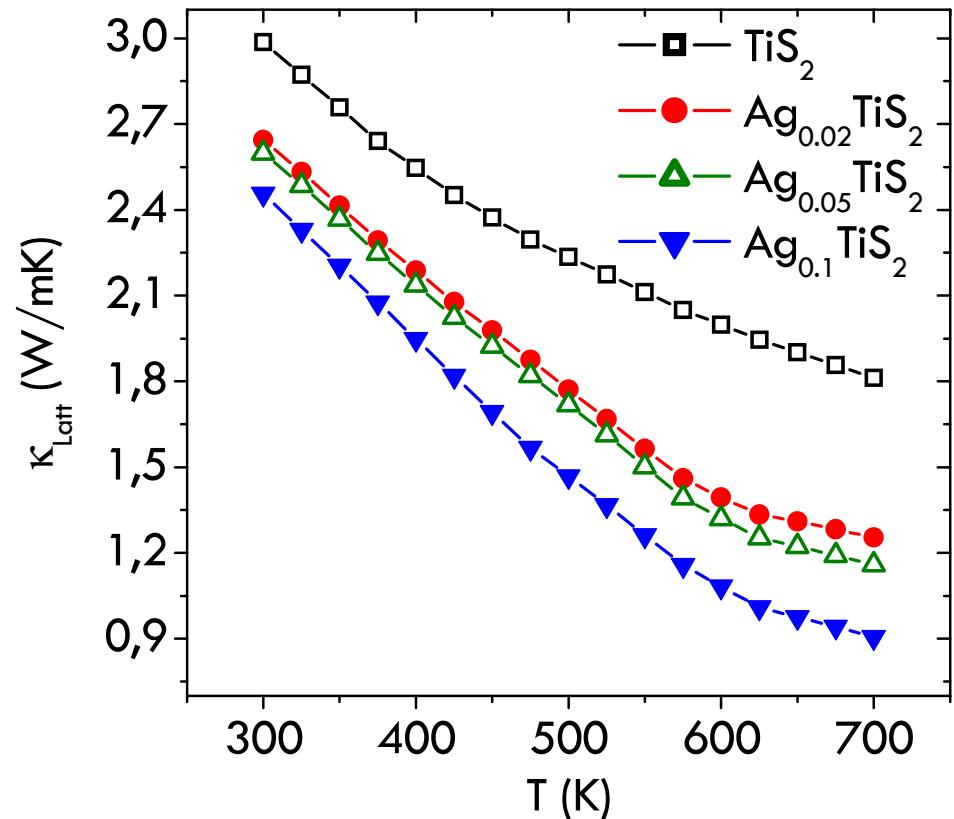


MS₂ compounds

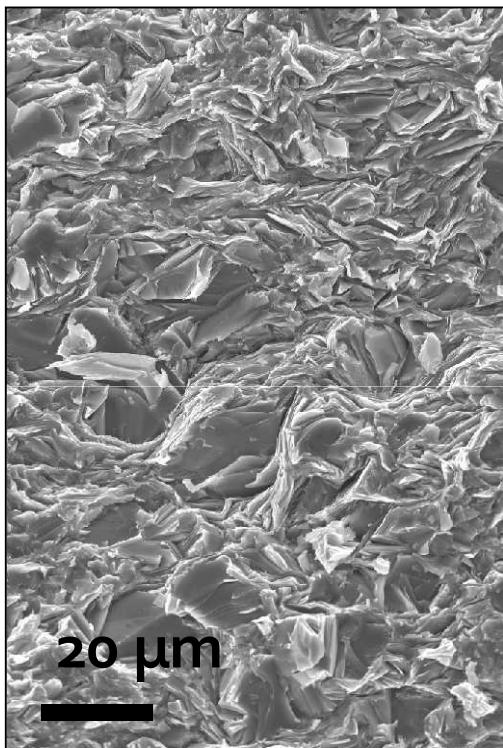
Intercalation

Substitution

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MS₂ compounds

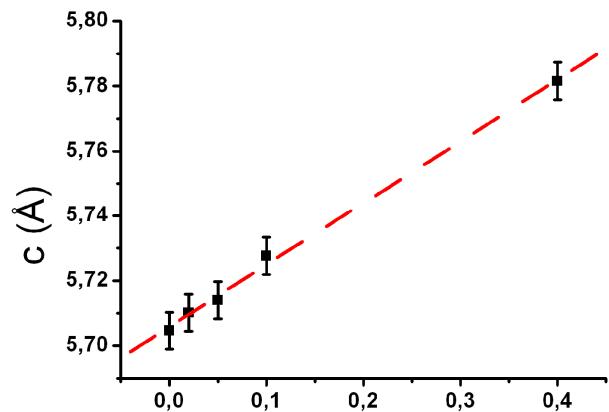
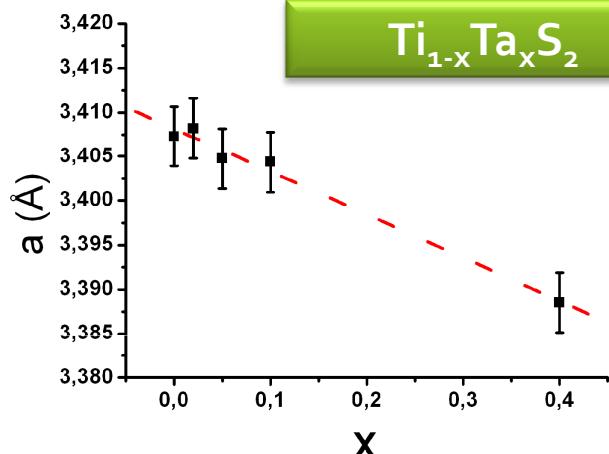
Intercalation

Substitution

Non-stoichiometry

Solid Solution $Ti_{1-x}Ta_xS_2$, $Ti_{1-x}Nb_xS_2$

□ Solid solution up to $x=0.4$



* $Ti_{1-x}Ta_xS_2$, M. Beaumale et al. JAP, 2014.

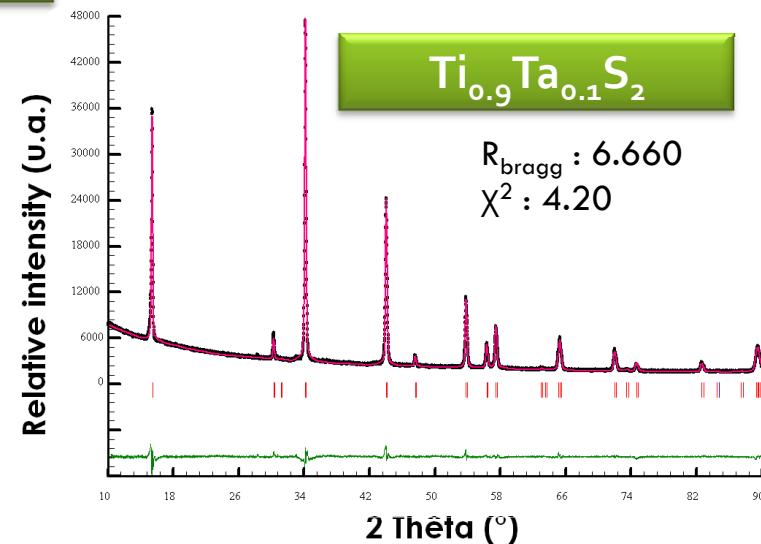
** $Ti_{1-x}Nb_xS_2$, M. Beaumale et al., J. Elec. Mater., 2014

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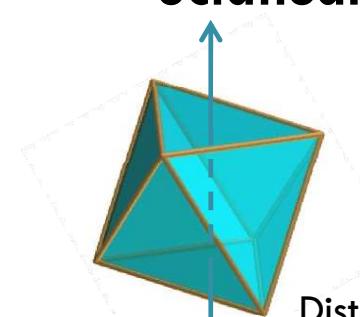
Intercalation

Substitution

Non-stoichiometry



Trigonal distortion of
octahedral coordination



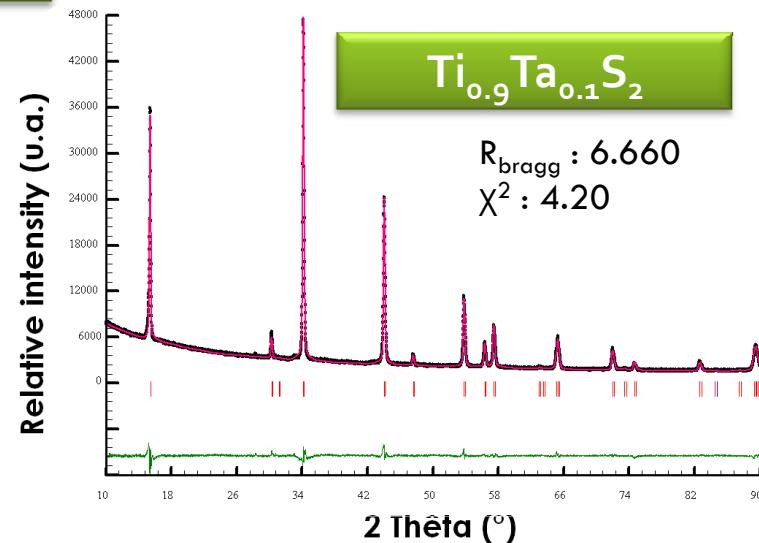
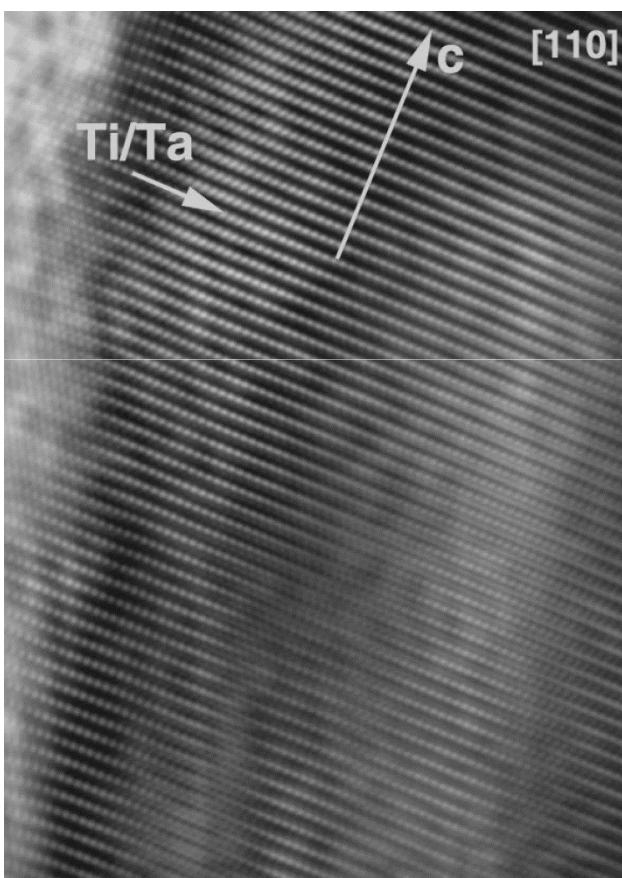
$Ta \rightarrow r = 0.78\text{\AA}$
 $Ti \rightarrow r = 0.745\text{\AA}$

Distortion along the 3-fold axis ***

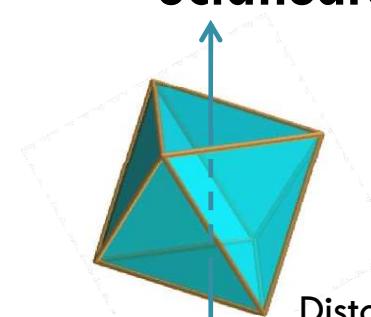
*** M. Shimakawa et al., MRB 32, 689 (1997)

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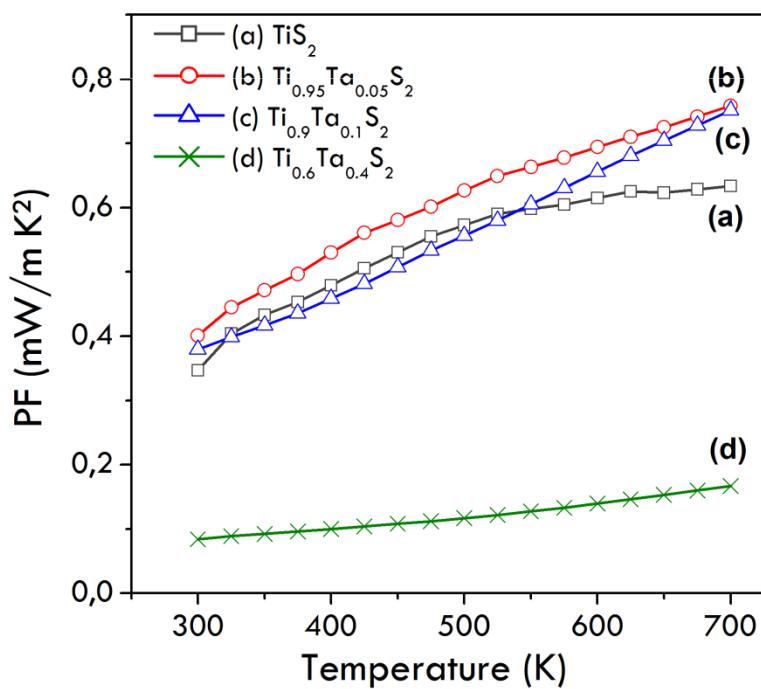
Intercalation

Substitution

Non-stoichiometry

Solid Solution $\text{Ti}_{1-x}\text{Ta}_x\text{S}_2$, $\text{Ti}_{1-x}\text{Nb}_x\text{S}_2$

- Solid solution up to $x=0.4$
- Increase in carrier concentration
- Sulfur non stoichiometry → low S

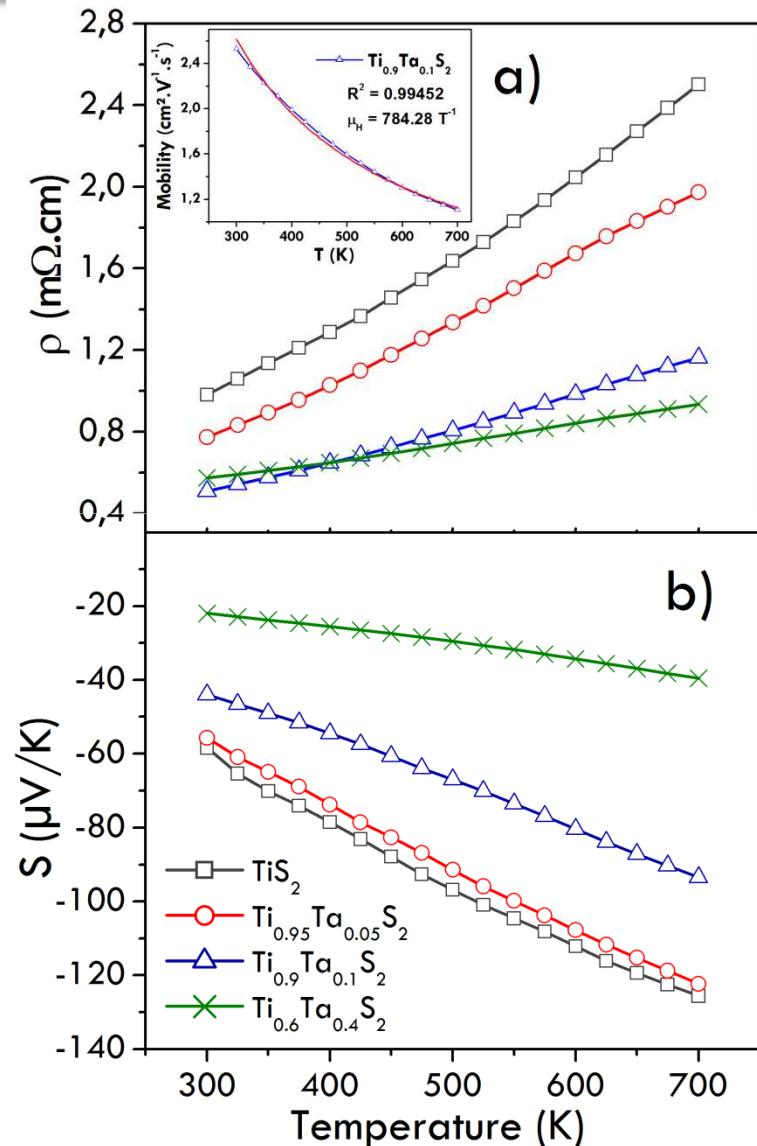


MS₂ compounds

Intercalation

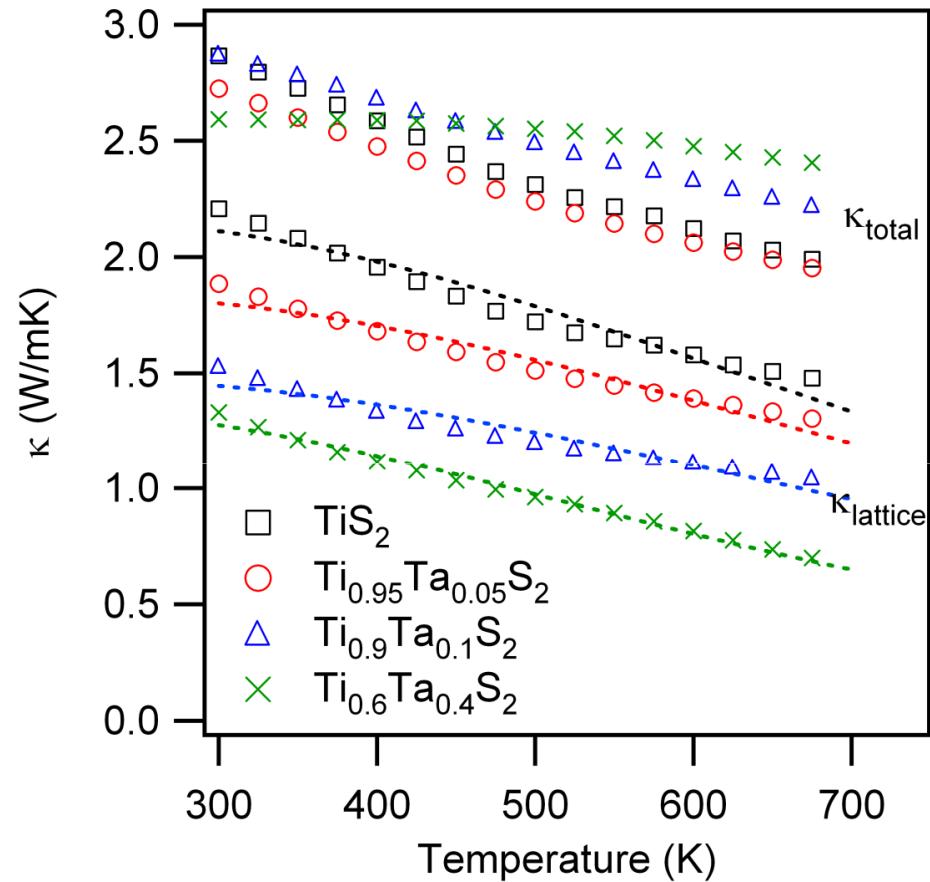
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- Sulfur non stoichiometry → low S
- Debye-Callaway → Mass fluctuation effect



MS₂ compounds

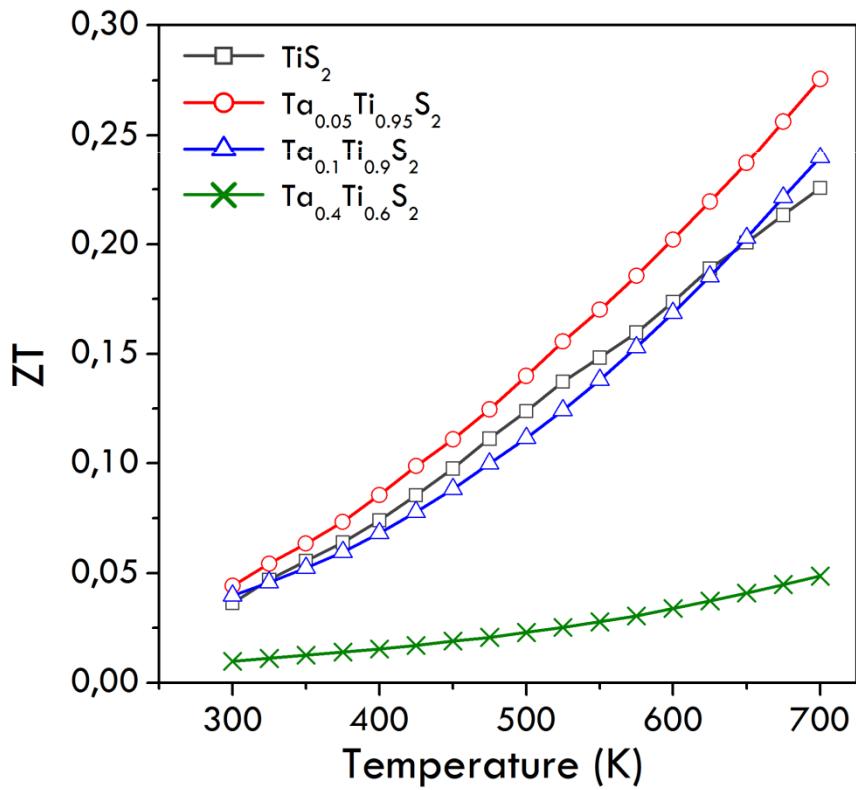
Intercalation

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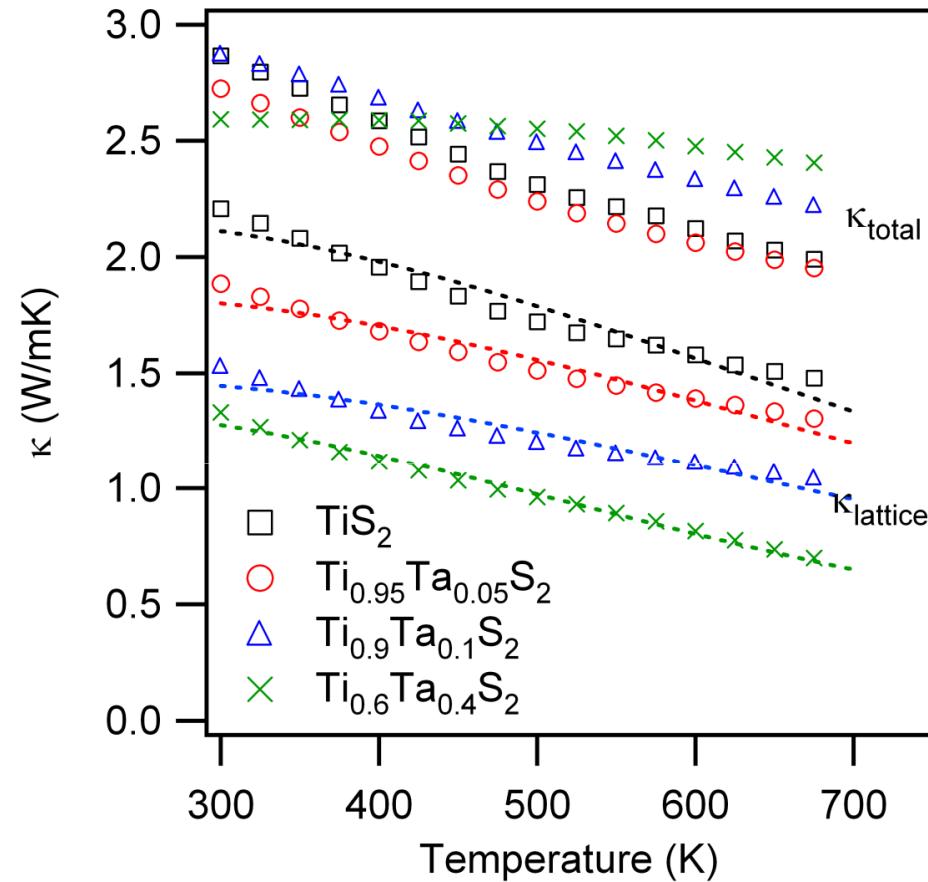


MS₂ compounds

Intercalation

Substitution

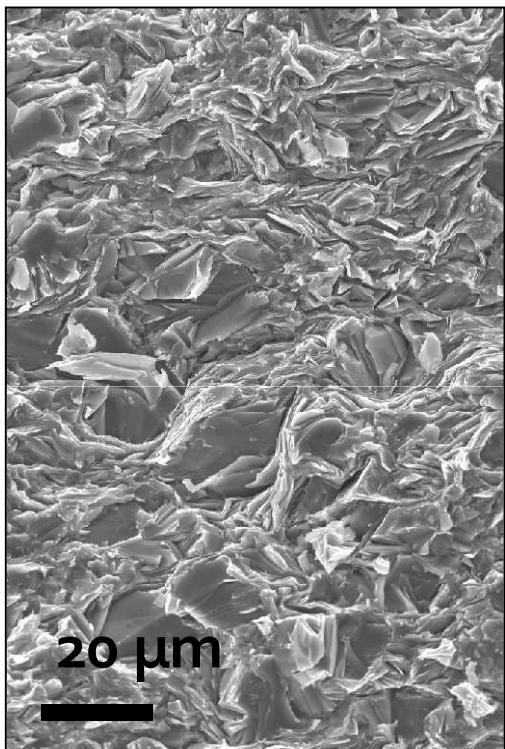
Non-stoichiometry



□ Increase in ZT up to 0.27 @ 700K
($x=0.05$)

□ Lower ZT due to sulfur loss (TiS_{2-x})

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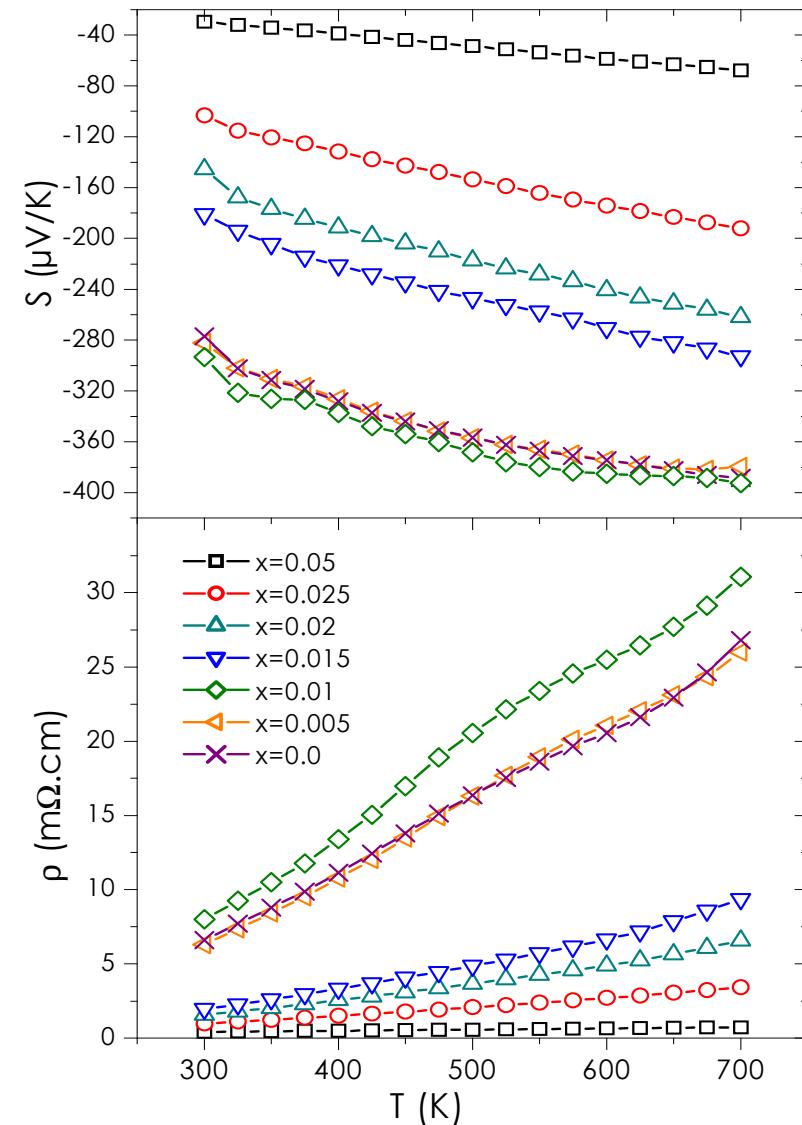
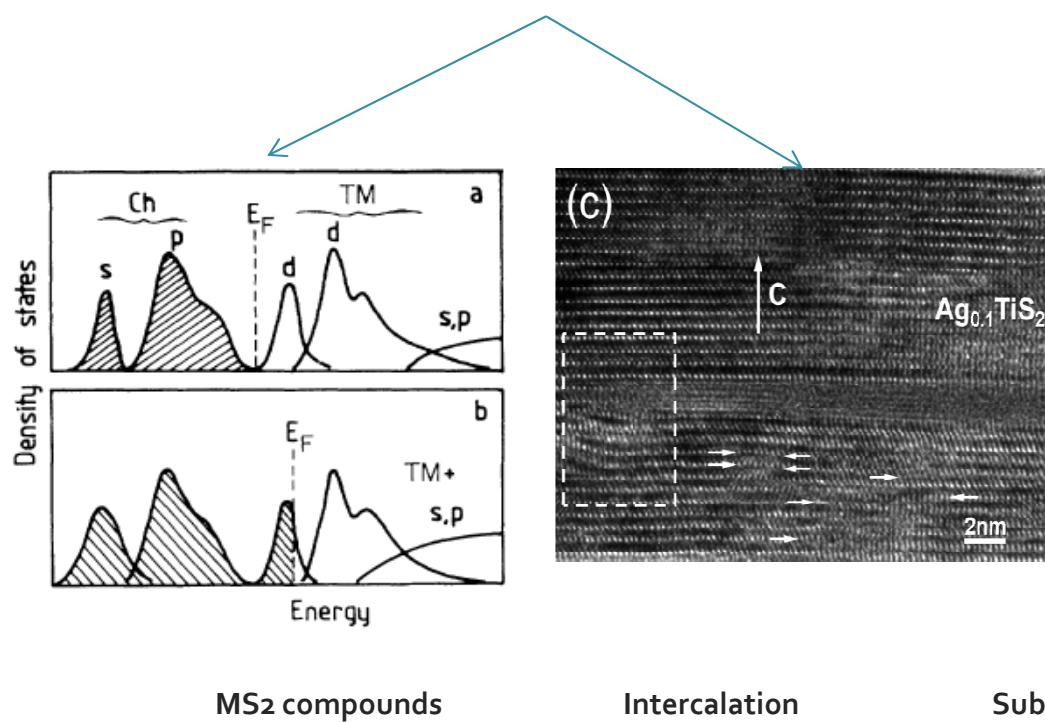
Intercalation

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Non-stoichiometry

$Ti_{1+x}S_2$: Non stoichiometry Approach

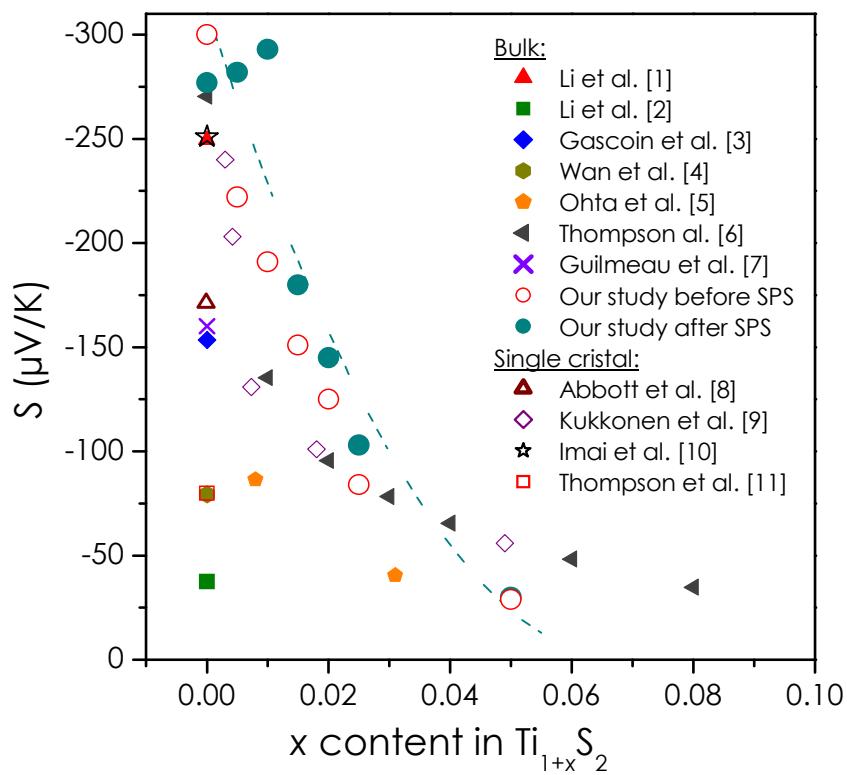
- ❑ S non Stoichio=Ti off-stoichiometry
→ intercalation
- ❑ Two effects within one chemical approach:
 - ❑ Optimization of PF (carrier conc.)
 - ❑ Structural disorder (intercalation)



$Ti_{1+x}S_2$: Non stoichiometry Approach

- Tuned carrier concentration
- Wide range of Seebeck coeff.

- Drastic decrease in κ_{tot}
- Ti intercalation \rightarrow disorder
- ZT improved up to 0.45 @ 700K

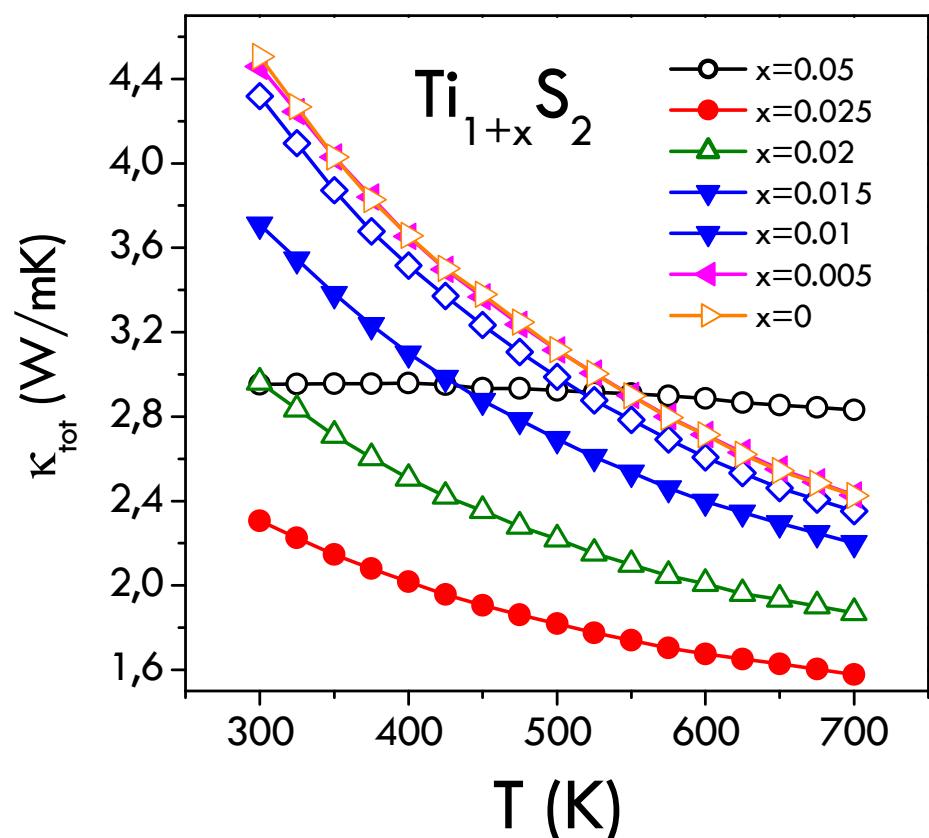


MS₂ compounds

Intercalation

Substitution

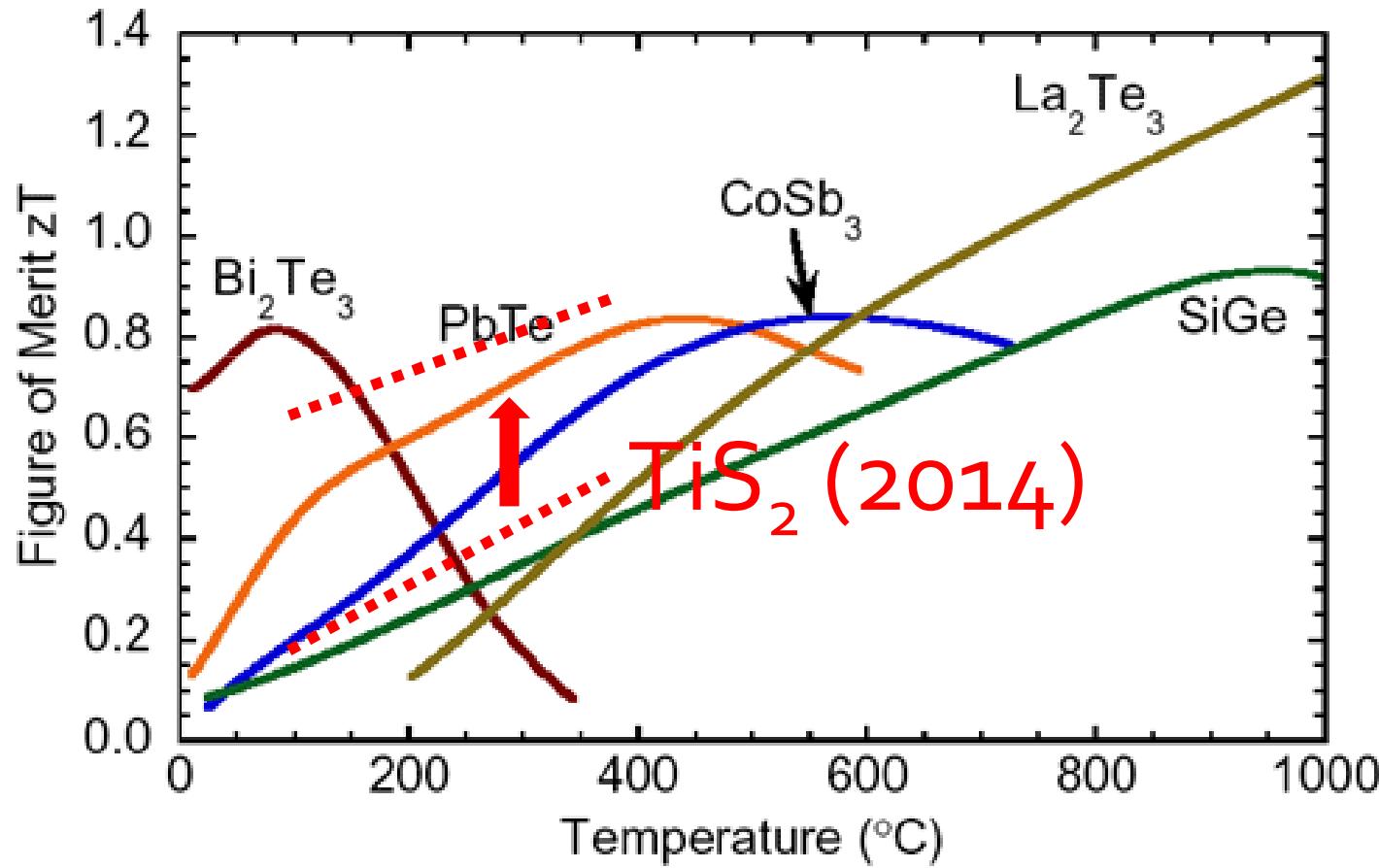
Non-stoichiometry



Conclusion

- 1.** Intercalation, Substitution, Non Stoichiometry
Three potential approaches to decrease kappa.
- 2.** Progress achieved with $ZT > 0.5$ @ 700K
- 3.** More efforts required to double ZT in the temperature range RT-700K

Conclusion



Acknowledgements

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Tristan Barbier
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A.V. Powell



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Thank you
for your attention!!!